

# SILICON SWITCHING DIODE **1SS303**

# **HIGH SPEED SWITCHING** SILICON EPITAXIAL DOUBLE DIODE: COMMON ANODE

75

### **FEATURES**

- Low capacitance: Ct = 2.5 pF TYP.
- High speed switching: trr = 4.0 ns MAX.
- Wide applications including switching, limitter, clipper.
- Double diode configuration assures economical use.

#### **ABSOLUTE MAXIMUM RATINGS**

Peak Reverse Voltage

Maximum Voltages and Currents (TA = 25°C)

DC Reverse Voltage	$V_{R}$	50	V
Surge Current (1 $\mu$ s) Note	IFSM	6.0	Α
Surge Current (1 $\mu$ s)	lгsм	4.0	A
Peak Forward Current Note	IFM	450	mA
Peak Forward Current	lгм	300	mA
Average Rectified Current Note	lo	150	mA
Average Rectified Current	lo	100	mA
Maximum Temperatures			
Junction Temperature	Tj	150	°C
Storage Temperature Range	Tstg	-55 to + 150	°C
Thermal Resistance			
Junction to Ambient Note	Rth(j-a)	1.0	°C/mW

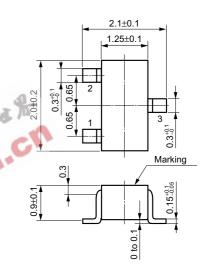
 $V_{RM}$ 

 $R_{th(j-a)}$ 

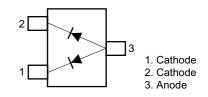
Note Both diodes loaded simultaneously.

Junction to Ambient

# **PACKAGE DIMENSIONS (Unit: mm)**



### **CONNECTION DIAGRAM (Top View)**



Marking: A4

## **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Forward Voltage	V <sub>F1</sub>	IF = 10 mA		0.72	1.0	V
	V <sub>F2</sub>	I <sub>F</sub> = 50 mA		0.88	1.1	V
	V <sub>F3</sub>	IF = 100 mA		1.0	1.2	V
Reverse Current	lR	VR = 50 V			0.1	μΑ
Capacitance	Ct	V <sub>R</sub> = 0 V, f = 1.0 MHz		2.5	4.0	pF
Reverse Recovery Time	trr	See Test Circuit.			4.0	ns

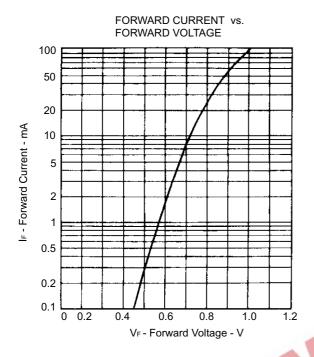
0.85

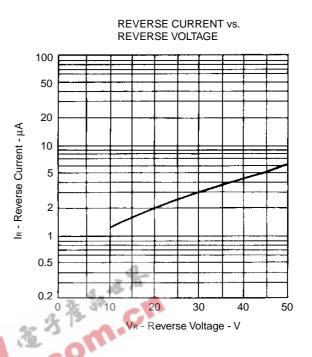
°C/mW

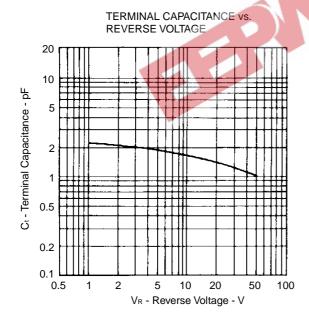
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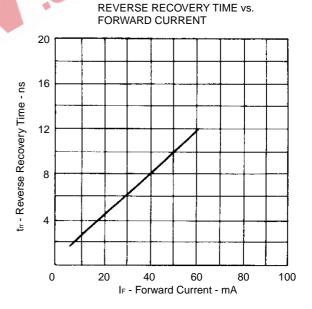
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## TYPICAL ELECTRICAL CURVES (TA = 25°C)

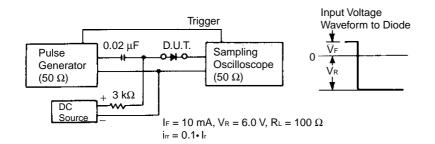


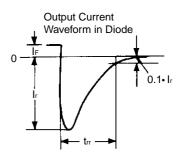






## REVERSE RECOVERY TIME (trr) TEST CIRCUIT







**NEC** 1SS303

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